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Intel® Xeon® Processor E5-2667 (15M Cache, 2.90 GHz, 8.00 GT/s Intel® QPI)

Specifications Essentials Performance Memory Specifications Expansion Options Package Specifications Advanced Technologies Intel® Data Protection Technology Intel® Platform Protection Technology Compatible Products Product Images

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Specifications - Essentials.			Related Products Intel® Xeon® Proces
Launch Date		Q1'12	
Processor Number		E5-2667	
Intel® Smart Cache		15 MB	
Intel® QPI Speed		8 GT/s	Quick Links Export Full Specification Search Distributors > Software Downloads : Support Overview > Search all of intel.com
# of QPI Links		2	
Instruction Set		64-bit	
Instruction Set Extensions		AVX	
Embedded Options Available	Q	No	
Lithography		32 nm	
Scalability		2S Only	PCN/MDDS Informate SROKP 919083: PCN MDDS SROH3 917890: PCN MDDS
VID Voltage Range		0.60V-1.35V	
Recommended Customer Price		TRAY: \$1552.00	
Datasheet		Link	
Performance			
# of Cores		6	

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12 # of Threads Processor Base Frequency 2.9 GHz Max Turbo Frequency 3.5 GHz TDP 130 W

 Memory Specifications Max Memory Size (dependent on memory type) 384 GB Memory Types DDR3 800/1066/1333/1600 Max # of Memory Channels 4 51.2 GB/s Max Memory Bandwidth ECC Memory Supported # Q Yes Expansion Options 3.0 PCI Express Revision 40 Max # of PCI Express Lanes Package Specifications

2

85.0°C

FCLGA2011

52.5mm x 45.0mm

Max CPU Configuration

CASE

Package Size

Sockets Supported

Low Halogen Options Available See MDDS Advanced Technologies Intel® Turbo Boost Technology * 2.0 Intel® vPro Technology * Q Yes Q Yes Intel® Hyper-Threading Technology * Intel® Virtualization Technology (VT-x) * Intel® Virtualization Technology for Directed I/O Q (VT-d) * Intel® VT-x with Extended Page Tables (EPT) # Q Yes Q Yes Intel® 64 * Idle States Q Enhanced Intel SpeedStep® Technology Intel® Demand Based Switching Q Yes Thermal Monitoring Technologies Intel® Flex Memory Access No Intel® Identity Protection Technology * No Intel® Data Protection Technology Q Yes **AES New Instructions** Intel® Platform Protection Technology

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Refer to Datasheet for formal definitions of product properties and features.

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"Announced" SKUs are not yet available. Please refer to the Launch Date for market availability. Some products can support AES New Instructions with a Processor Configuration update, in particular, i7-2630QM/i7-2635QM, i7-2670QM/i7-2675QM, i5-2430M/i5-2435M, i5-2410M/i5-2415M. Please contact

OEM for the BIOS that includes the latest Processor configuration update. # This feature may not be available on all computing systems. Please check with the system vendor to determine if your system delivers this feature, or reference the system specifications (motherboard, processor, chipset, power supply, HDD, graphics controller, memory, BIOS, drivers, virtual machine monitor-VMM, platform software, and/or operating system) for feature compatibility. Functionality,

performance, and other benefits of this feature may vary depending on system configuration. "Conflict free" and "conflict-free" means "DRC conflict free", which is defined by the U.S. Securities and Exchange Commission rules to mean products that do not contain conflict minerals (tin, tantalum,

tungsten and/or gold) that directly or indirectly finance or benefit armed groups in the Democratic Republic of the Congo (DRC) or adjoining countries. Intel also uses the term "conflict-free" in a broader sense to refer to suppliers, supply chains, smelters and refiners whose sources of conflict minerals do not finance conflict in the DRC or adjoining countries. Intel processors manufactured before January 1, 2013 are not confirmed conflict free. The conflict free designation refers only to product manufactured after that date. For Intel Boxed Processors, the conflict free designation refers to the processor only, not to any additional included accessories, such as heatsinks/coolers.

See http://www.intel.com/content/www/us/en/architecture-and-technology/hyper-threading-technology.html?wapkw=hyper+threading for more information including details on which processors support Intel® HT Technology. Max Turbo Frequency refers to the maximum single-core processor frequency that can be achieved with Intel® Turbo Boost Technology, See www.intel.com/technology/turboboost/ for more information.

The Recommended Customer Price ("RCP") is pricing guidance for Intel products. Prices are for direct Intel customers, typically represent 1,000-unit purchase quantities, and are subject to change without notice. Taxes and shipping, etc. not included. Prices may vary for other package types and shipment quantities, and special promotional arrangements may apply. Listing of these RCP does not constitute a formal pricing offer from Intel. Please work with your appropriate Intel representative to obtain a formal price quotation.

System and Maximum TDP is based on worst case scenarios. Actual TDP may be lower if not all I/Os for chipsets are used. Low Halogen: Applies only to brominated and chlorinated flame retardants (BFRs/CFRs) and PVC in the final product. Intel components as well as purchased components on the finished assembly meet

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JS-709 requirements, and the PCB / substrate meet IEC 61249-2-21 requirements. The replacement of halogenated flame retardants and/or PVC may not be better for the environment. For benchmarking data see http://www.intel.com/performance.

Intel processor numbers are not a measure of performance. Processor numbers differentiate features within each processor family, not across different processor families. See http://www.intel.com/content

/www/us/en/processors/processor-numbers.html for details. Processors that support 64-bit computing on Intel® architecture require an Intel 64 architecture-enabled BIOS.

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